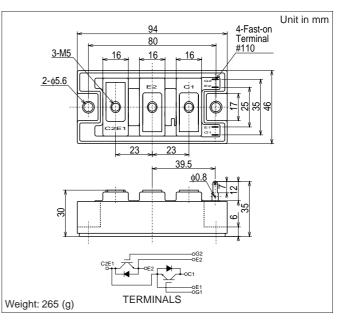
MBM400GS6AW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



Item		Symbol	Unit	MBM400GS6AW	
Collector Emitter Voltage	VCES	V	600		
Gate Emitter Voltage	V _{GES}	V	±20		
Collector Current	DC	Ic	А	400	
	1ms	I _{Cp}	A	800	
Forward Current	DC	١ _F	А	400 (1)	
	1ms	FM	A	800	
Collector Power Dissipation		Pc	W	1,000	
Junction Temperature	Tj	°C	-40 ~ +150		
Storage Temperature	T _{stg}	°C	-40 ~ +125		
Isolation Voltage		V _{ISO}	V _{RMS}	2,500(AC 1 minute)	
Screw Torque Terr	ninals	-	N.m	1.96(20) (2)	
Mou	nting	-	(kgf.cm)	1.96(20) (3)	

ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

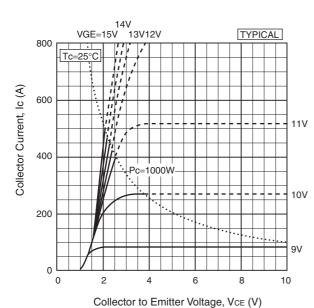
Notes:(1)RMS Current of Diode 120Arms max. (2)(3)Recommended Value 1.67N.m(17kgf.cm)

CHARACTERISTICS (Tc=25°C)

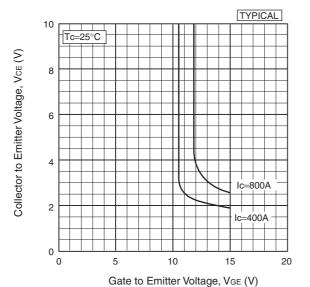
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	1.0	$V_{CE}=600V, V_{GE}=0V$
Gate Emitter Leakage Current		IGES	nA	-	-	±500	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		VCE(sat)	V	-	1.9	2.5	Ic=400A, V _{GE} =15V
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	-	-	10	V _{CE} =5V, I _C =400mA
Input Capacitance		Cies	рF	-	20,000	-	V _{CE} =10V,V _{GE} =0V,f=1MHz
	Rise Time	tr		-	0.25	0.5	V _{CC} =300V
Switching Times	Turn On Time	ton	μS	-	0.35	0.7	R∟=0.75Ω
5	Fall Time	t _f		-	0.25	0.35	$R_{G}=6.2\Omega \tag{4}$
	Turn Off Time	t _{off}		-	0.8	1.1	V _{GE} =±15V
Peak Forward Voltage Drop		VFM	V	-	2.2	3.0	IF=400A, VGE=0V
Reverse Recovery Time		trr	μS	-	-	0.3	I _F =400A,V _{GE} =-10V, di/dt=400A/µs
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.125	Junction to case
	FWD	Rth(j-c)		-	-	0.25	1

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.

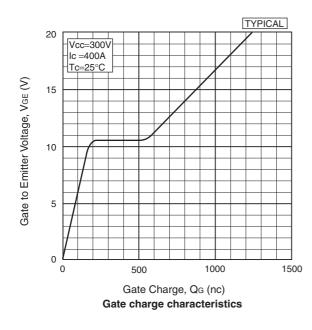
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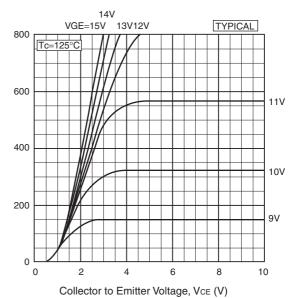




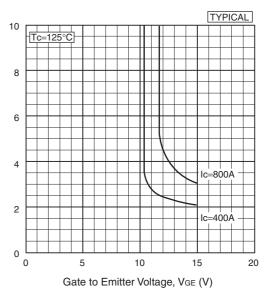


Collector to Emitter voltage vs. Gate to Emitter voltage

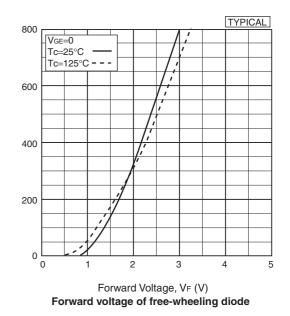




Collector current vs. Collector to Emitter voltage

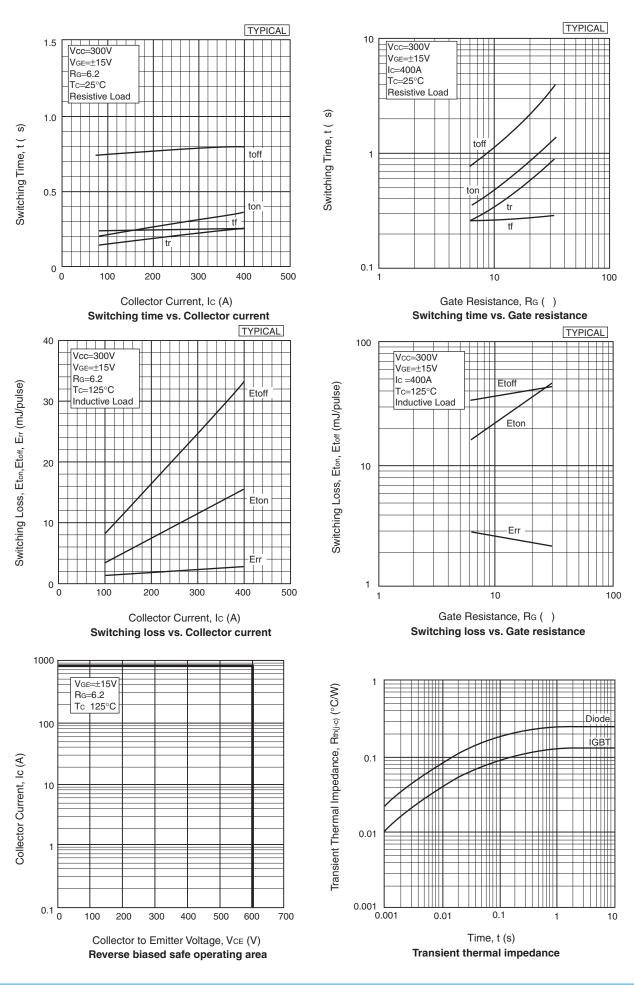


Collector to Emitter voltage vs. Gate to Emitter voltage



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PDE-M400GS6AW-0



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PDE-M400GS6AW-0

HITACHI POWER SEMICONDUCTORS

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